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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Shih-Fang Chuang

Docket Number: TI-36243

Serial No.: 10/717,731

Art Unit: 2814

Filed: 11/20/2003

Examiner: Hoai V. Pham

For: LOW COEFFICIENT OF THERMAL EXPANSION (CTE)

SEMICONDUCTOR PACKAGING MATERIALS

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SHIH-FANG CHUANG TITLE OF INVENTION: LOW COEFFICINET OF THERMAL TIFILE NO: DEPOSE ACCULATION:		Serial No.: 10/717,731 Conf. No: 8713
TI-36243	DEPOSIT ACCT. NO.: 20-0668	
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